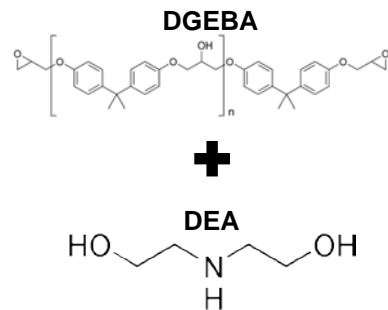
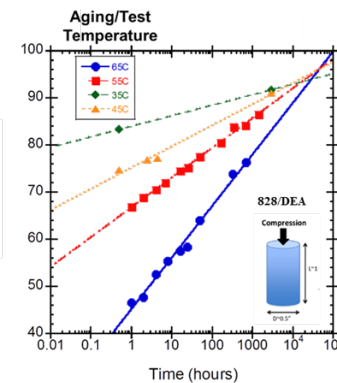
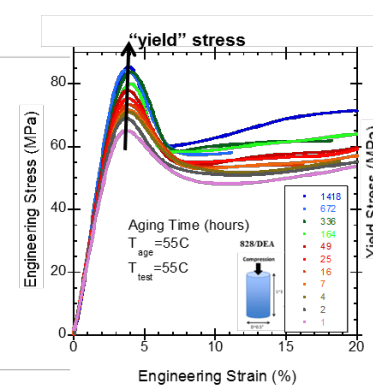
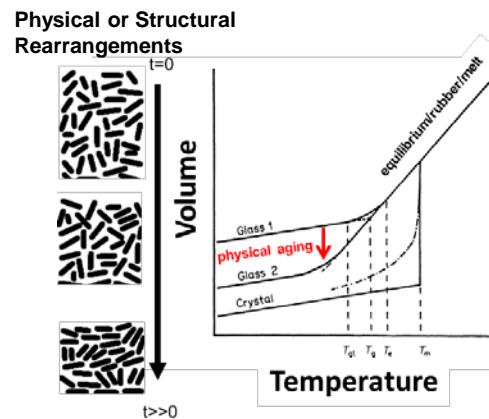
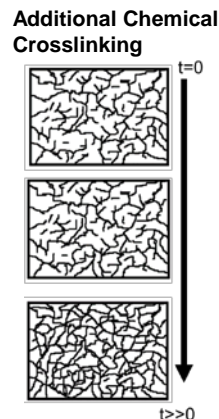


Materials



Thermal-Mechanical Response Changes



Understanding and Predicting the Evolution of Glassy Thermoset Polymers During Aging

Jamie M. Kropka, Sandia National Laboratories, Albuquerque, NM

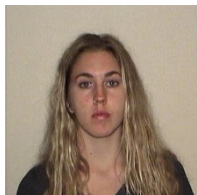
Materials Engineering Graduate Seminar, New Mexico Tech, February 15, 2018

Polymer Physics, Characterization, Modeling and Processing Group

Experimentalists



Kelsey Wilson



Lindsey Hughes



Doug Adolf (retired)



Taylor Gabaldon



Rex Jaramillo



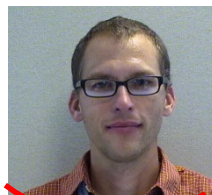
Mark Stavig



Nick Wyatt



Jamie Kropka



Cody Corbin



Mat Celina



John McCoy (NM Tech)



Modelers



Bob Chambers (retired)



Kevin Long



Brenton Elisberg



Craig Tenney



Kurtis Ford



Matthew Neidigk (AFRL)



some past and present students

Jason Sharkey (NM Tech/SNL)

Caitlyn Clarkson (NM Tech/SNL)

Gabe Arechederra (NM Tech/SNL)

Jasmine Hoo (NM Tech)

Lara Draelos (NM Tech)

Maggie House (NM Tech)

Windy Ancipink (NM Tech)



Main Contributors to Today's Topics



How are Polymers Used at SNL?

- Encapsulants for:
 - structural integrity
 - impact
 - vibration
 - high voltage isolation
- Adhesives or Underfills for:
 - bonding materials
 - surface mount components
- Printed Circuit Boards:
 - orthotropic composites

thermosets

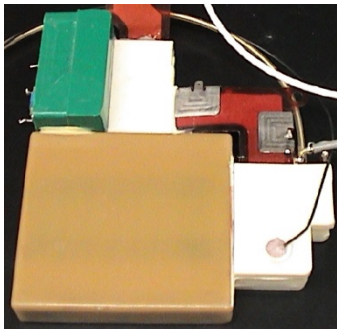
- Foams for:
 - energy dissipation
 - light constraints

- Plastic Parts for:
 - injection molded pieces

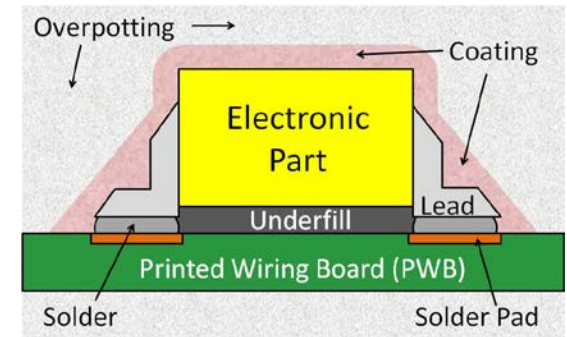
thermoplastics

- Gaskets and O-rings for:
 - sealing cavities
- Cushions, Pads, Coatings for:
 - stress relief
 - damping

elastomers



- Optimal use of polymers is not always obvious
- Poor choice of polymers can cause premature failures
- Modeling is important
- Must understand materials to represent them in models



Polymers Are Complex Materials

They respond differently than metals and ceramics

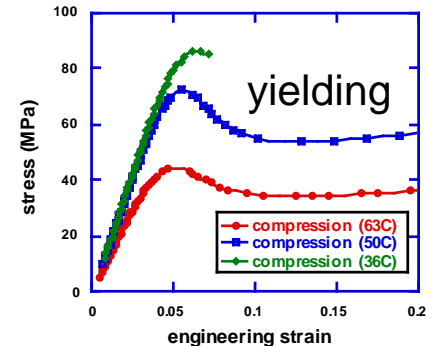
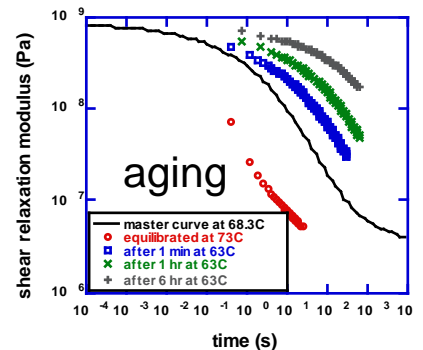
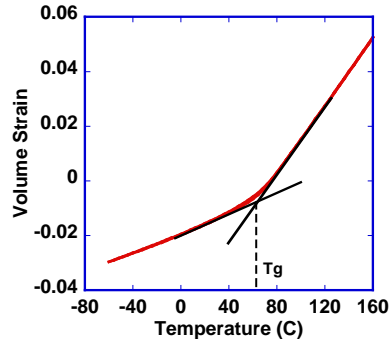
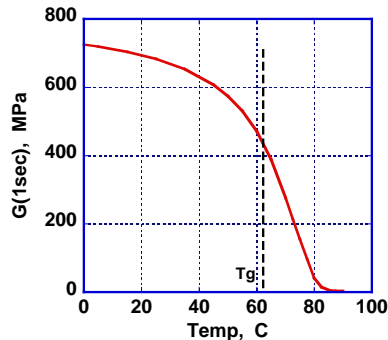


exhibit a glass transition:

- shear modulus can change by 2-3 orders of magnitude
- CTE can change by factor of 3

time dependent and nonlinear:

- relaxation rates vary with temperature and load

Behavior depends on thermal and strain histories

Performance predictions must be able to capture the full range of behavior for general thermo-mechanical loadings from manufacturing to failure.

- must be extensively validated
- computationally tractable

What We Do

1. Capability Development (relevant to Encapsulation and Bonding)
 - a. Understanding of Polymer Material Structure-Processing-Properties Relationships
 - b. Understanding of Stress in Polymers
2. Material Properties Analysis
3. Problem Solving

Our Vision: Validated Model-Based Lifecycle Engineering for Packaging Design

Polymer Nonlinear Viscoelastic (NLVE) Model

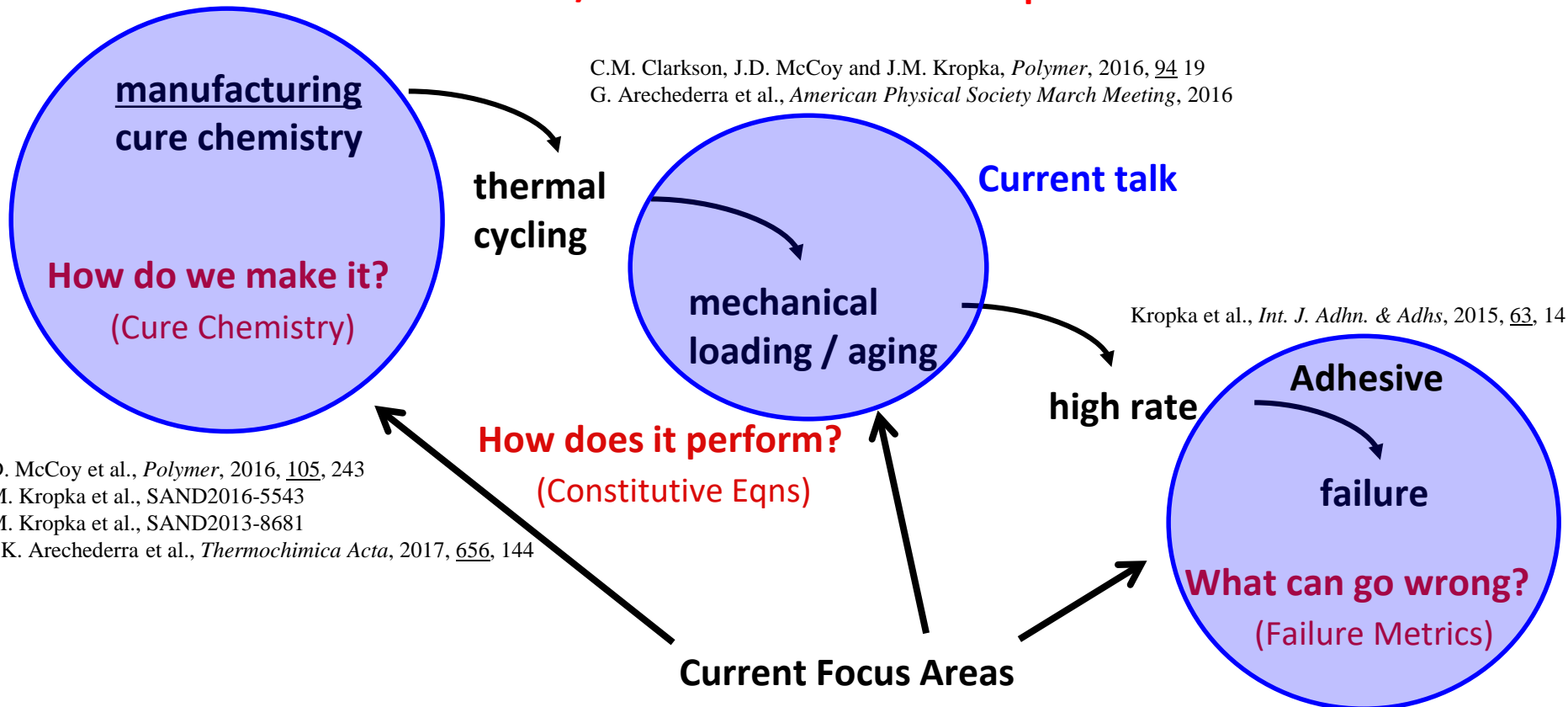
J.M. Caruthers, et al., *Polymer*, 2004, 45, 4577

D.B. Adolf, et al., *Polymer*, 2004, 45, 4599

D.B. Adolf, et al., *Polymer*, 2009, 50, 4257

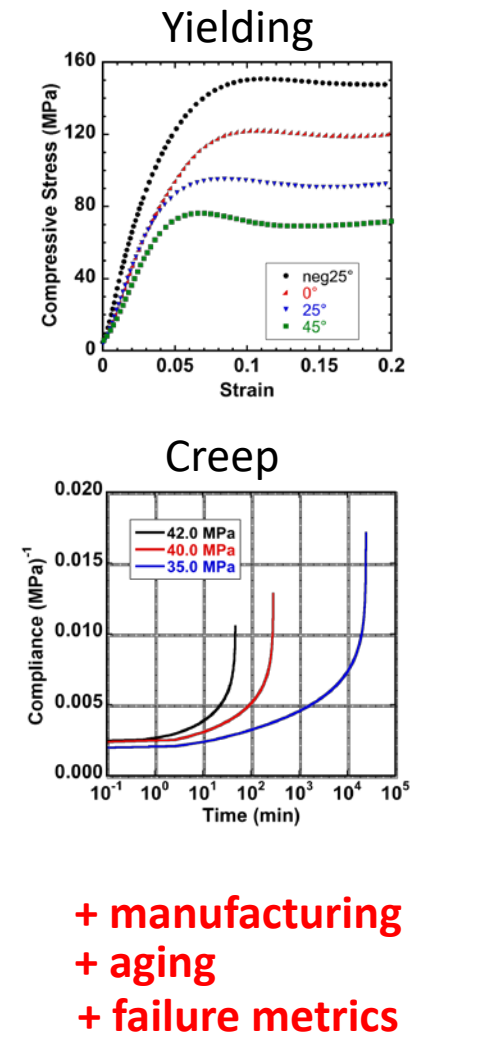
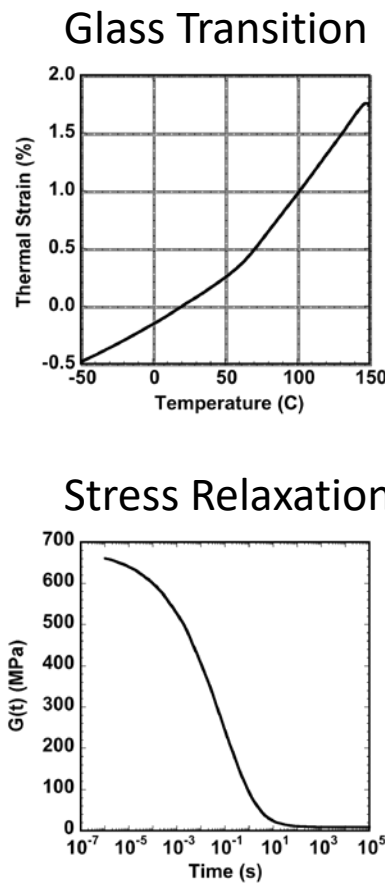
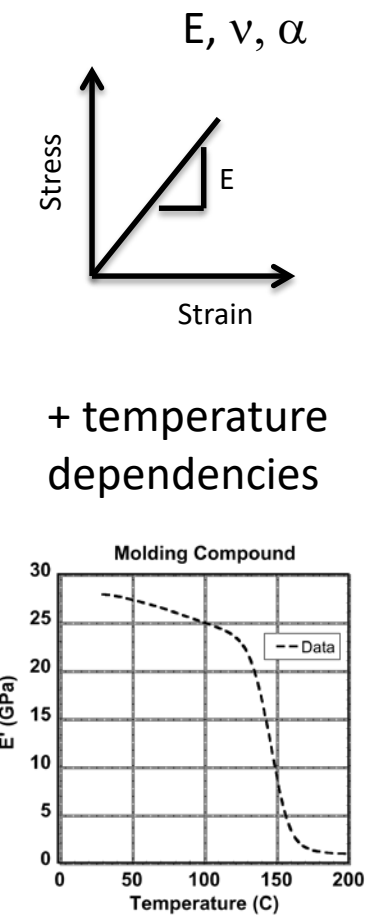


Predict Stress/Strain and Understand Impact on Performance



Capability Development: Evolution of Constitutive Representation of Polymers

Linear Elasticity Linear Viscoelasticity Nonlinear Viscoelasticity



Hierarchy of Polymer Material Characterization for Modeling

Nonlinear Viscoelasticity (NLVE)

Other Options not Possible

Material Evaluations

Critical Encapsulants/Adhesives

Bare Bones Approach

Measure:

1. calorimetric Tg

2. filler volume fraction

Model Parameterization:

Estimate NLVE response based on universal properties and rule of mixtures approach

Limitations/Potential Errors:

• Must be rigid fillers (e.g., alumina, silica, mica...)

• Breadth of relaxation spectra

• Nonlinear material clock

Quick and Dirty Approach

Measure:

1. filler volume fraction

2. thermal strain versus temperature

3. elastic shear modulus versus temperature

Model Parameterization:

Estimate NLVE response based on universal properties and rule of mixtures approach. Compare predictions to data. Ability to tweak relaxation spectra and prefactors to better match predictions to data.

Limitations/Potential Errors:

Lack definition of clock for nonlinear relaxations

The Whole Shebang

Measure:

1. filler volume fraction

2. thermal strain versus temperature

3. elastic shear modulus versus temperature

4. compressive stress-strain through yield at multiple temperatures

5. shear mastercurve

6. glassy volume relaxation

7. creep at multiple temperatures and stress levels

8. Material evolution during cure

Model Parameterization:

Populate material specific SPEC NLVE model

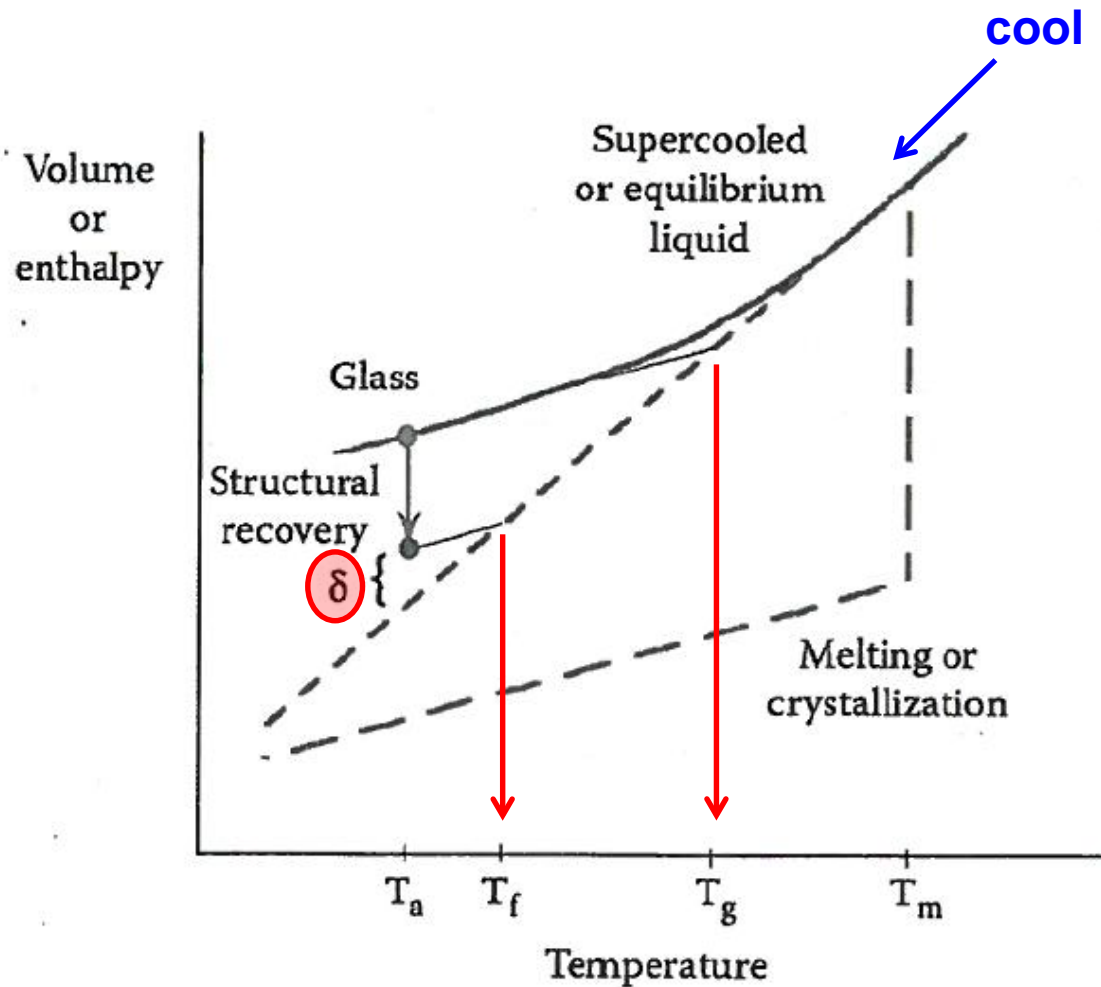
Advantage:

Model can now predict yielding AND (physical) aging with more confidence

Polymer Glass Aging Topics

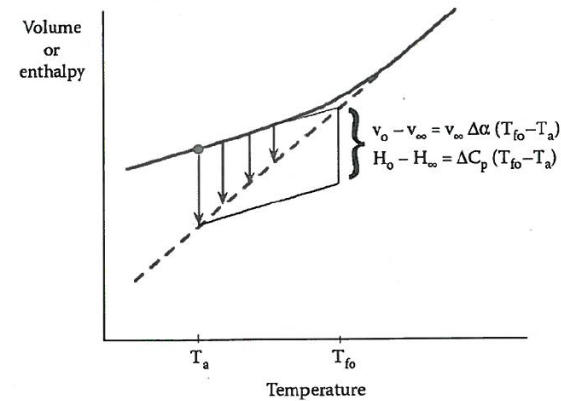
- Background
 - Glass Formation and Structural Recovery/Relaxation
 - Signatures and Impact of Structural Recovery/Relaxation
 - What is lacking in our understanding and what is left to do?
- Our Current Efforts
 - Goals
 - Materials
 - Volume and mechanical response changes associated with aging
 - Assessment of impact of aging on stress and failure in application relevant geometries
 - Simple structural response tests validate predictive tools

Glass Formation and Structural Recovery/Relaxation

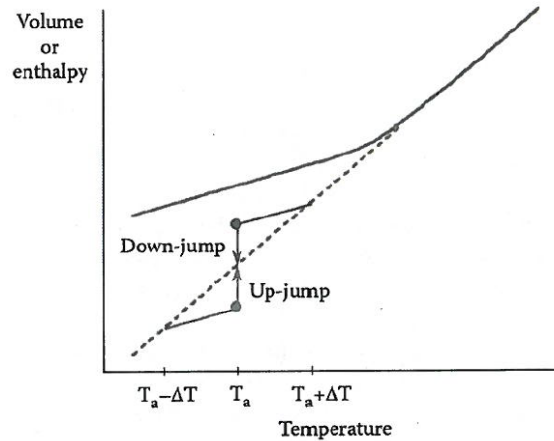


Signatures of Structural Recovery/Relaxation

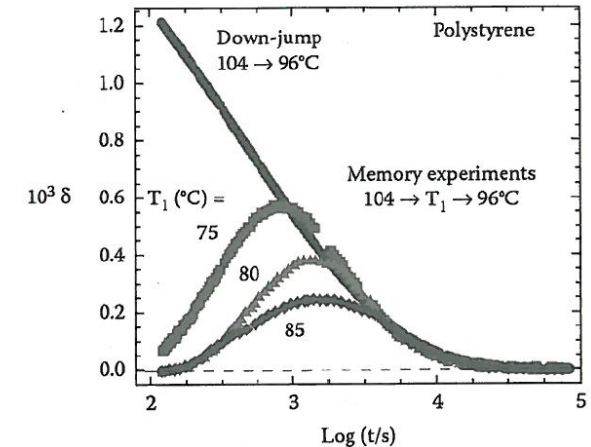
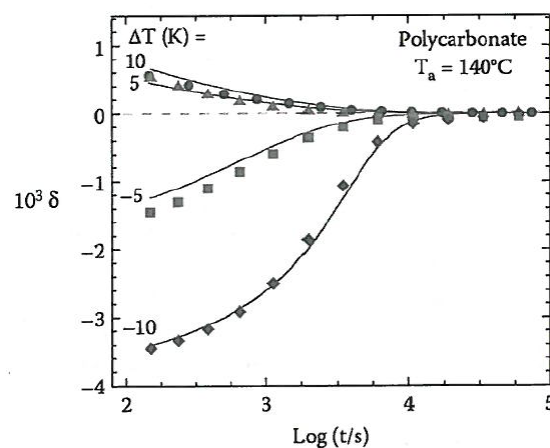
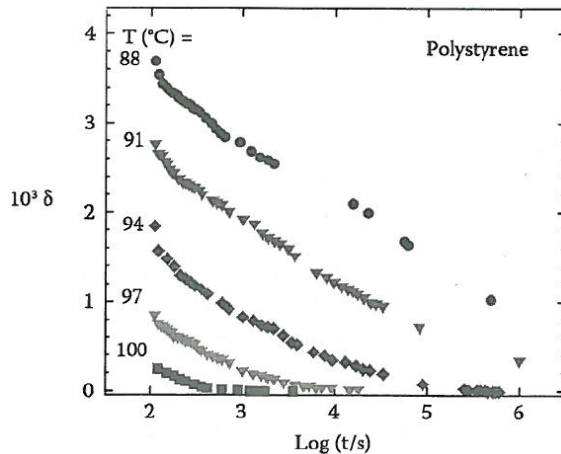
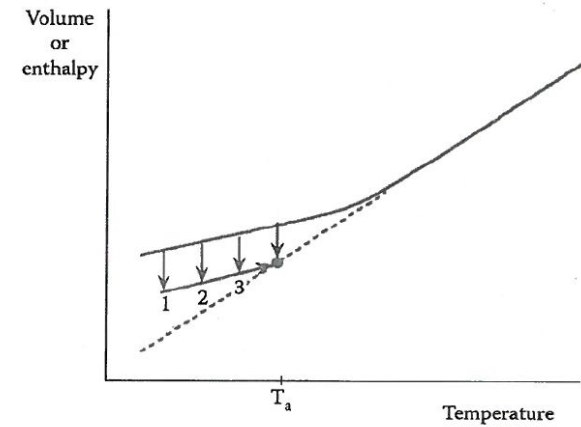
Intrinsic Isotherms



Asymmetry of Approach



Memory Effect



Relaxation Depends on Structure

Relaxation Depends on History

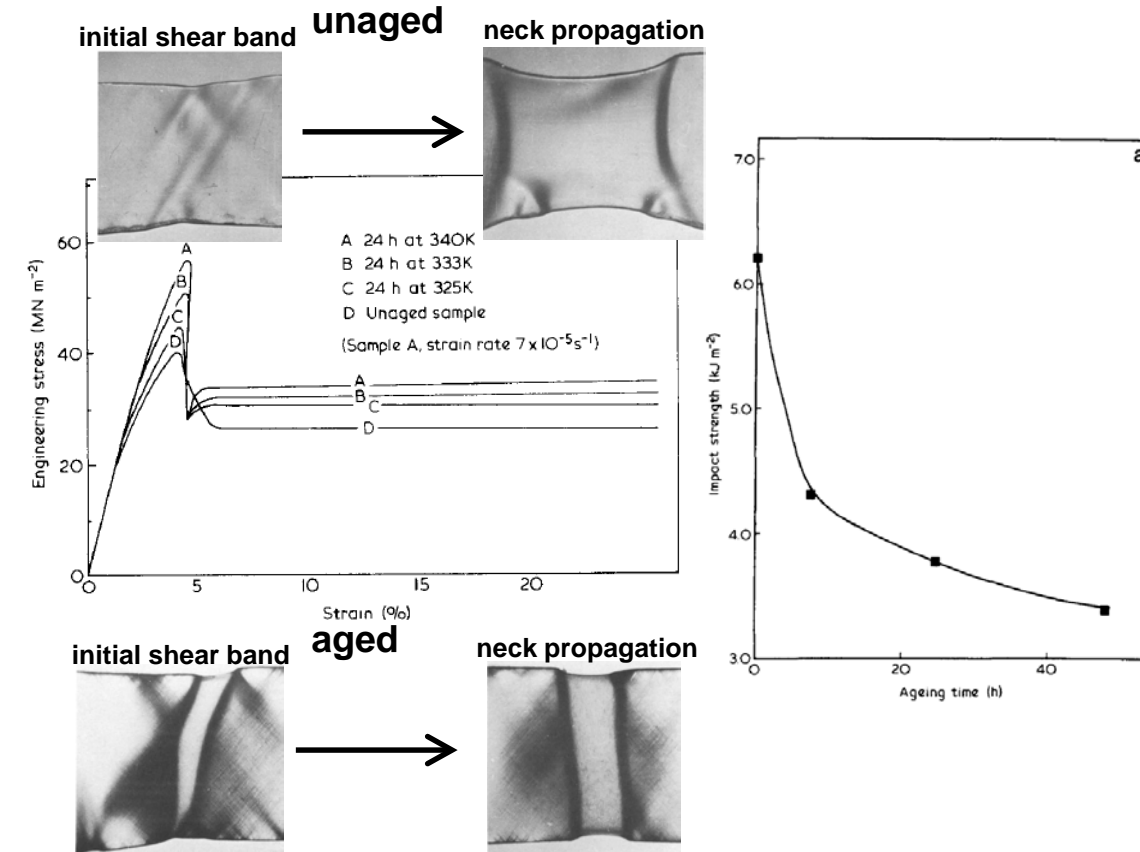
KAHR and TNM models capture qualitative features of glassy kinetics and the 3 signatures of structural recovery

Impact of Structural Recovery and Physical Aging

“Failure modes of polymers can change from ductile to brittle failure with aging”

S.L. Simon and G.B. McKenna, in *Polymer Glasses*, 2017, pg. 46

Tensile and impact tests of PET during isothermal “aging”



Izod impact studies of PC during isothermal “aging”

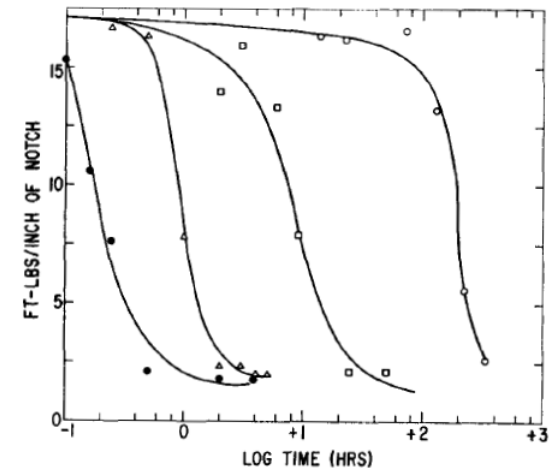


Fig. 3. Effect of annealing temperature on Izod impact data. ○) 100; □) 115; △) 125; ●) 130; $[\eta] = 0.58$.

D.G. Legrand, *J. Appl. Pol. Sci.*, 1969, **13** 2129

R.N. Haward et al., *Polymer*, 1983, **24** 1245

These are thermoplastics, but the phenomena can occur in thermosets too

What is left to do?

“Further work and direct measurement of the volume and enthalpy along with the mechanical (physical aging) experiments should be undertaken on the same samples”

S.L. Simon and G.B. McKenna, in *Polymer Glasses*, 2017

- Currently probing epoxy volume/enthalpy relaxation plus changes in mechanical response AND using this information to design “strength” experiments in application relevant geometries

“...because the (KAHR and TNM) models do still exhibit some difficulties in quantitative prediction with model parameters showing a dependence on thermal history...” efforts are necessary to improve upon these models

S.L. Simon and G.B. McKenna, in *Polymer Glasses*, 2017

- Currently testing Sandia’s non-linear viscoelastic modeling capabilities against aging data

Approach to Understanding/Predicting Epoxy Aging

- Identify material aging mechanisms and their impact on material physical behavior (**current efforts and results**)
- Develop/augment science-based modeling tools to predict material aging behavior with high fidelity
- Demonstrate impact of aging on stress in application relevant geometries (**scoping tests**)
- Validate predictive tools in application relevant geometries (**scoping tests**)

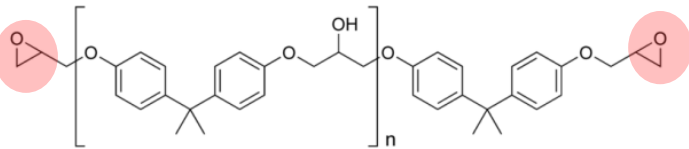
Is physical aging a concern in terms of stress evolution in application designs?

Materials

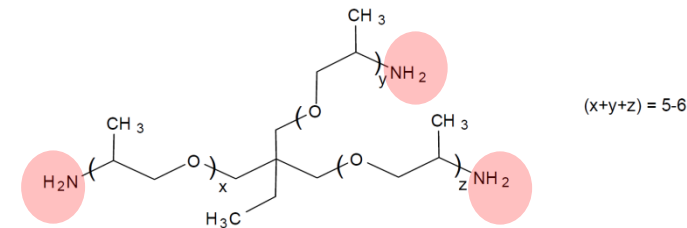
828/T403¹ and 828/GMB/T403

EPON[®] Resin 828

Diglycidylether of Bisphenol-A



Jeffamine® T-403 Polyetheramine

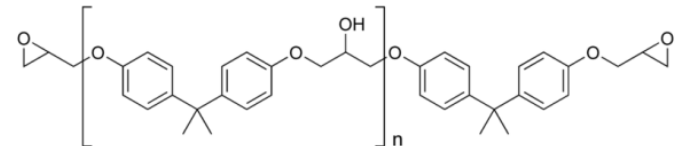

$$T_{ba} \sim 90^\circ\text{C}$$

(when mixed stoichiometrically epoxy-amine)

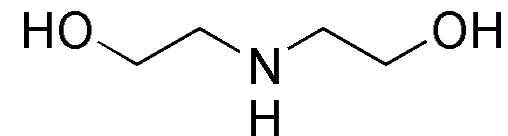
828/DEA² and 828/GMB/DEA³

EPON[®] Resin 828

Diglycidylether of Bisphenol-A



Diethanolamine



McCoy et al. *Polymer* **2016**, *105*, 243–254.

3M D32 glass microballoons

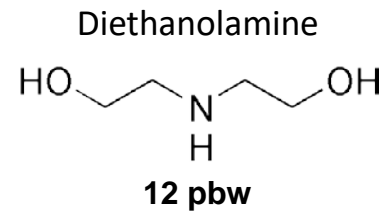
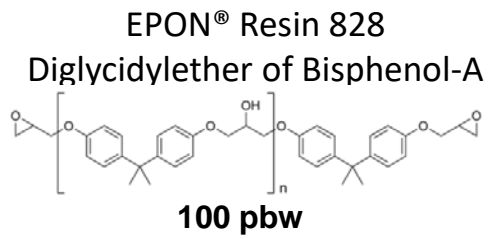
 $T_{ba} \sim 70C$

¹Mix ratio, cure schedule, and more can be found in SAND2013-8681

²Mix ratio, cure and typical properties can be found at: http://www.sandia.gov/polymer-properties/828_DEA.html

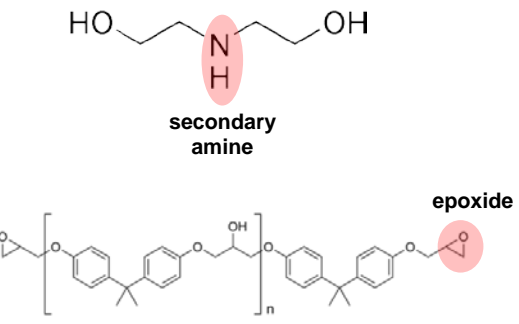
³Mix ratio, cure and typical properties can be found at: http://www.sandia.gov/polymer-properties/828_DEA_GMB.html

828/DEA¹



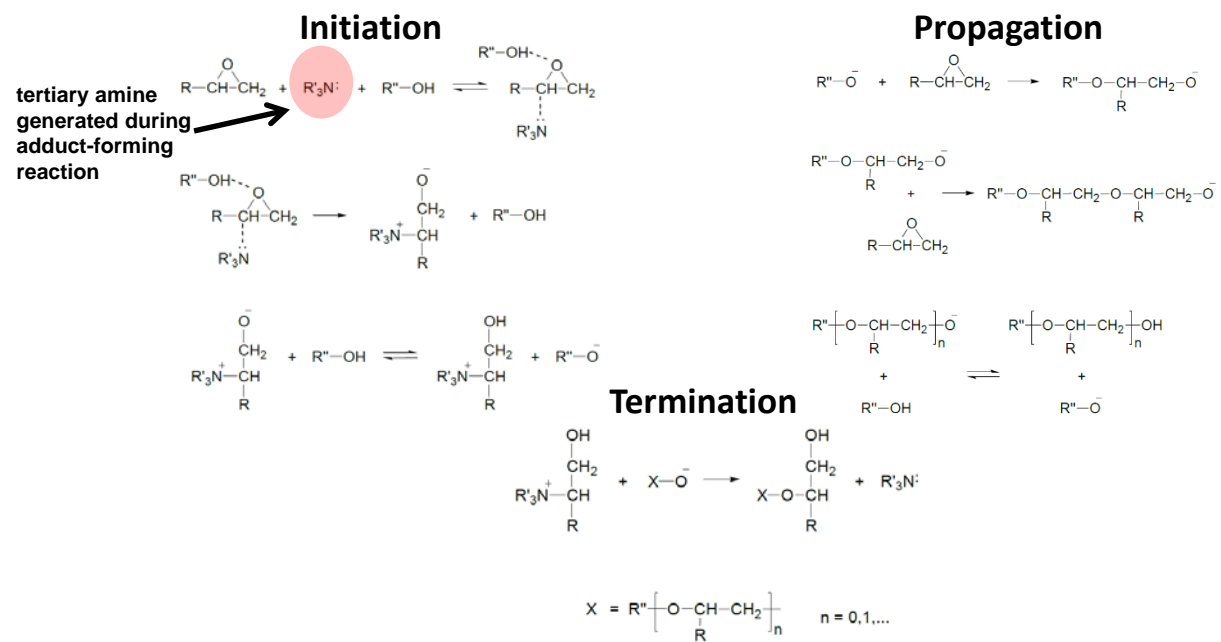
Polymerization at T = 70°C (the cure process before aging)

Adduct-Forming Reaction



All secondary amine is consumed in an addition reaction and excess epoxide remains

Proposed Gelation Reaction



Anionic Chain-Growth Polymerization Catalyzed by Tertiary Amine from Adduct-Forming Reaction

J.D. McCoy et al., *Polymer*, 2016, 105, 243

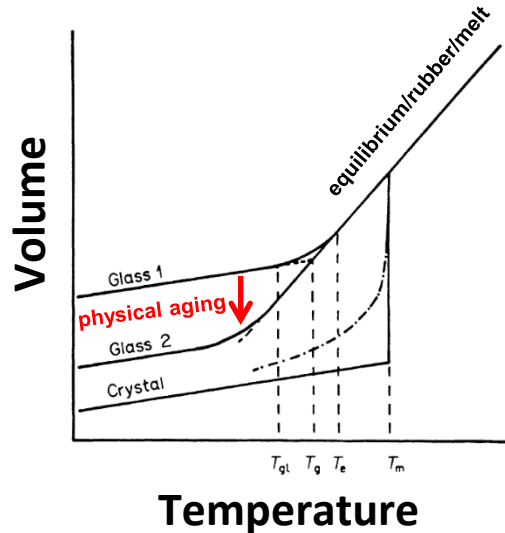
$T_g \sim 70^\circ\text{C}$

[when mixed 100:12 (pbw) 828:DEA and cured 24 hours at T=70°C]

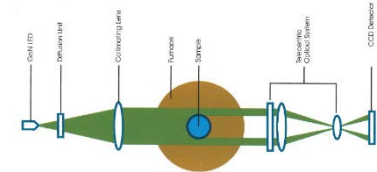
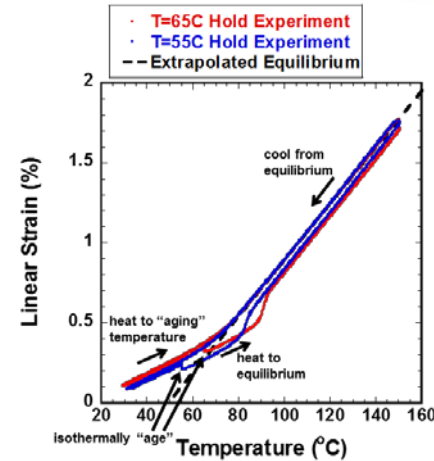
¹Mix ratio, cure and typical properties can be found at: http://www.sandia.gov/polymer-properties/828_DEA.html

Polymer Glass Aging

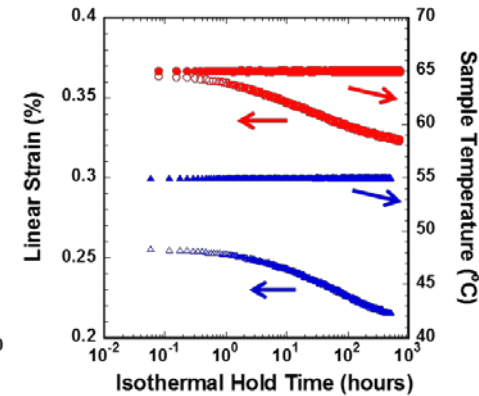
Material Volume Changes



optical resolution

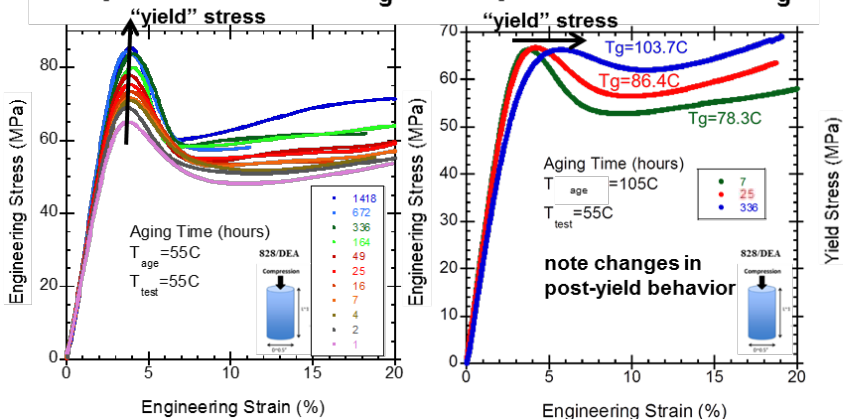


Isothermal Hold Response

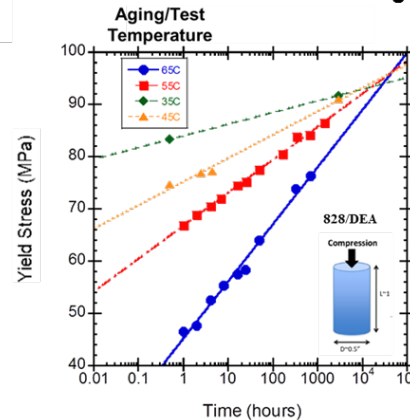


Material Mechanical Response Changes

Exposure Below T_g Exposure Above T_g



Exposure Below T_g

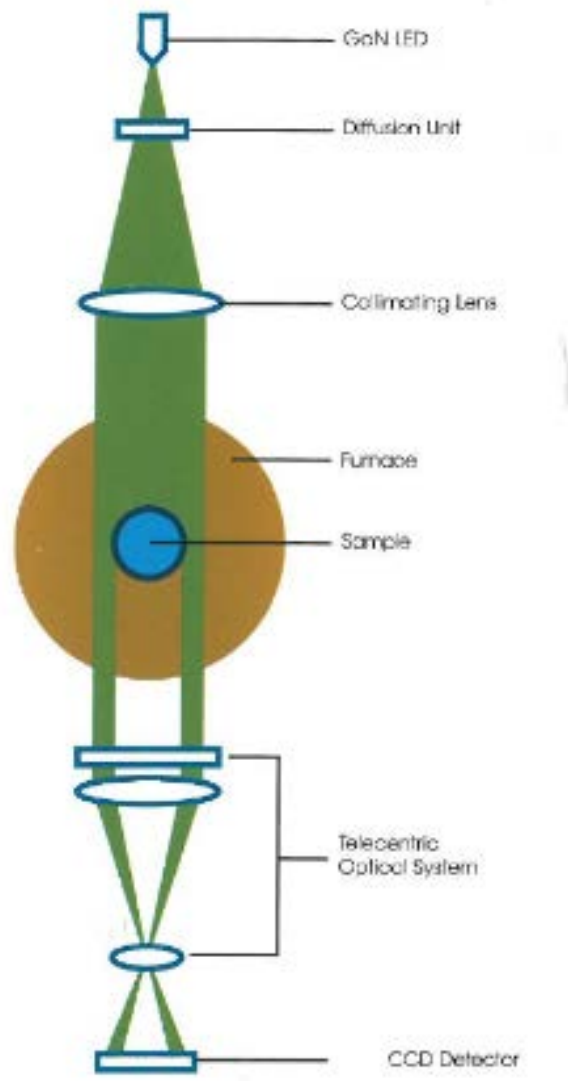


SNL NLVE polymer models (e.g., SPEC) have the framework to predict the aging behavior and should be tested against measurements

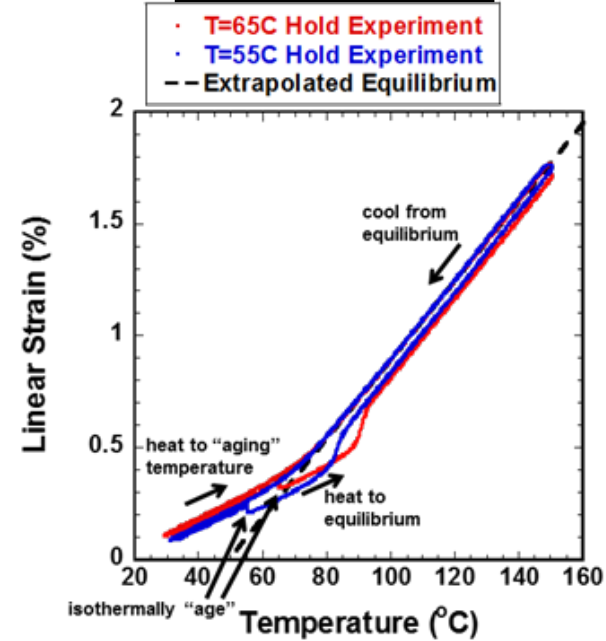
Volume

Measuring Volume Response Associated with Aging

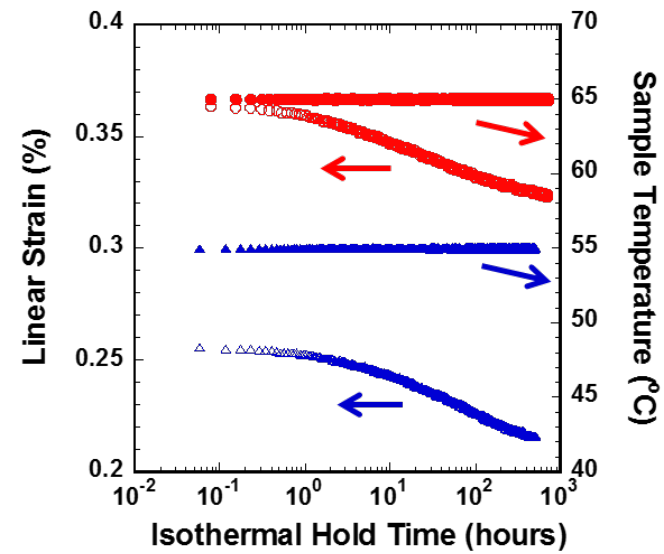
Optical Resolution of Length*



Full Experiment

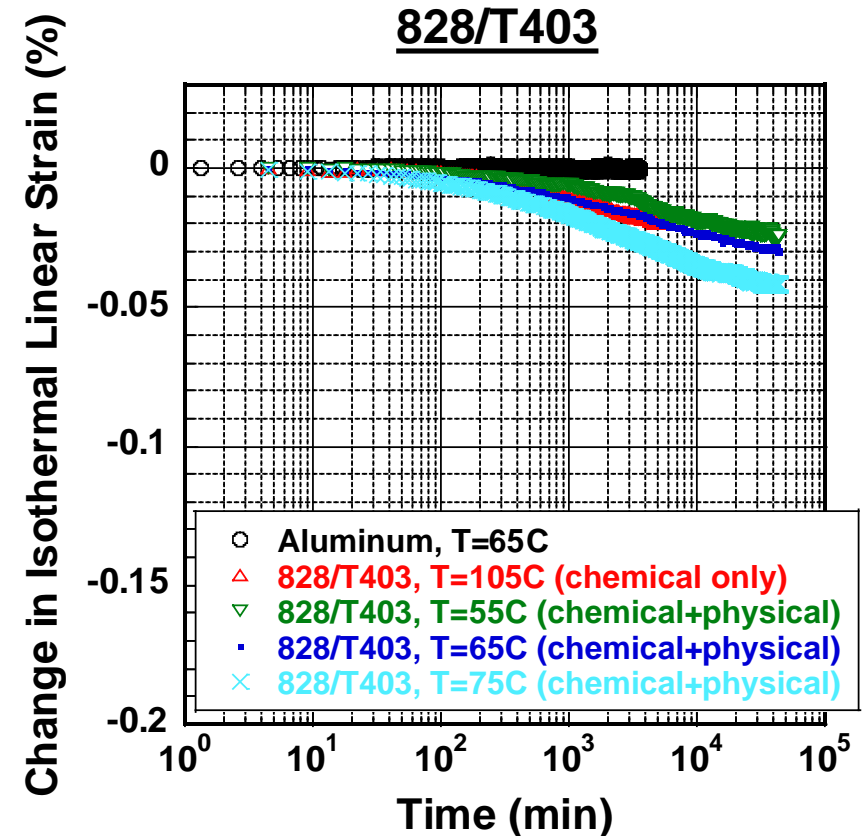
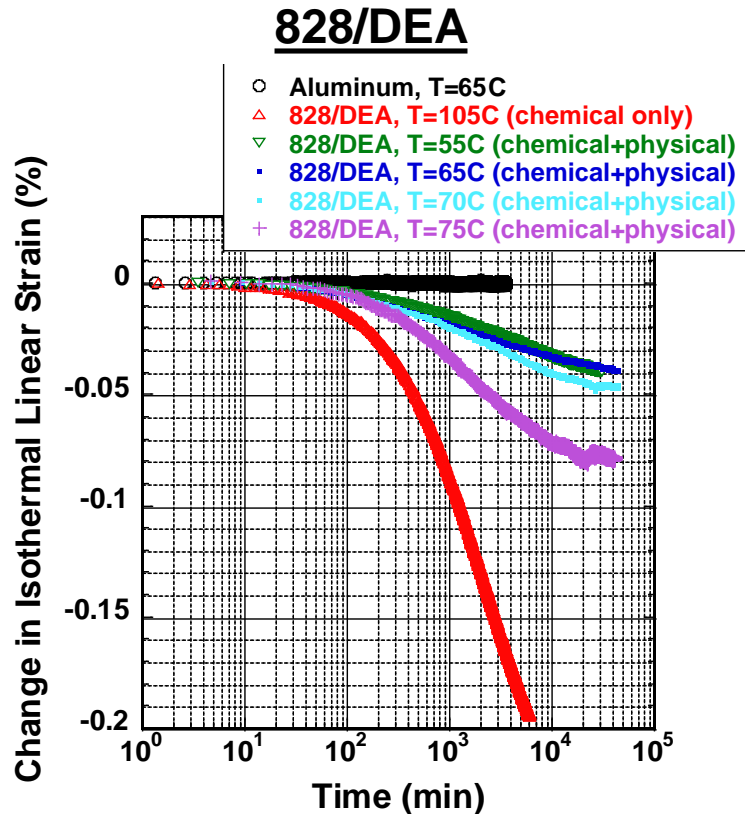


Isothermal Hold Response



*for isotropic materials $\Delta V=3\Delta L$

Isothermal Volume Response for 2 Common Epoxy Thermosets

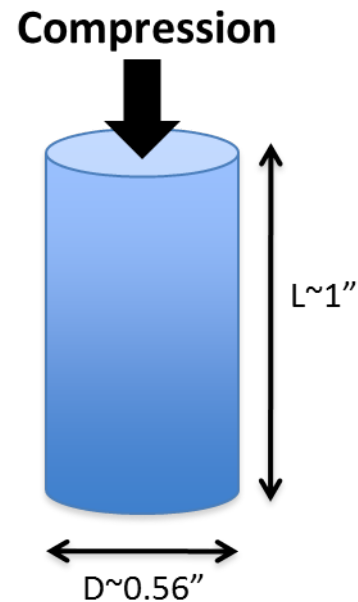
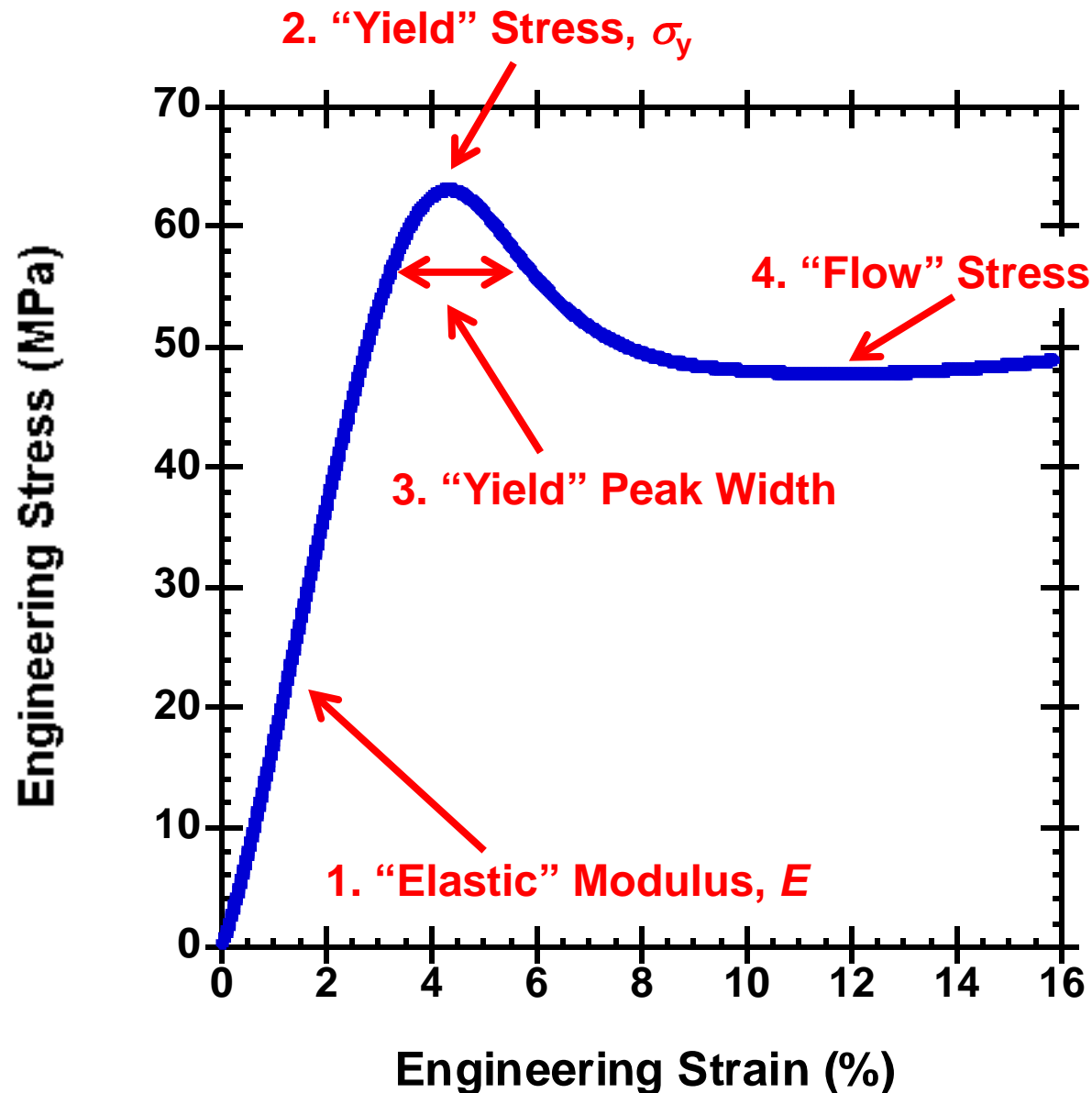


Note: Remaining reactive potential (excess epoxide groups in the case of 828/DEA) can play a significant role in total volume change

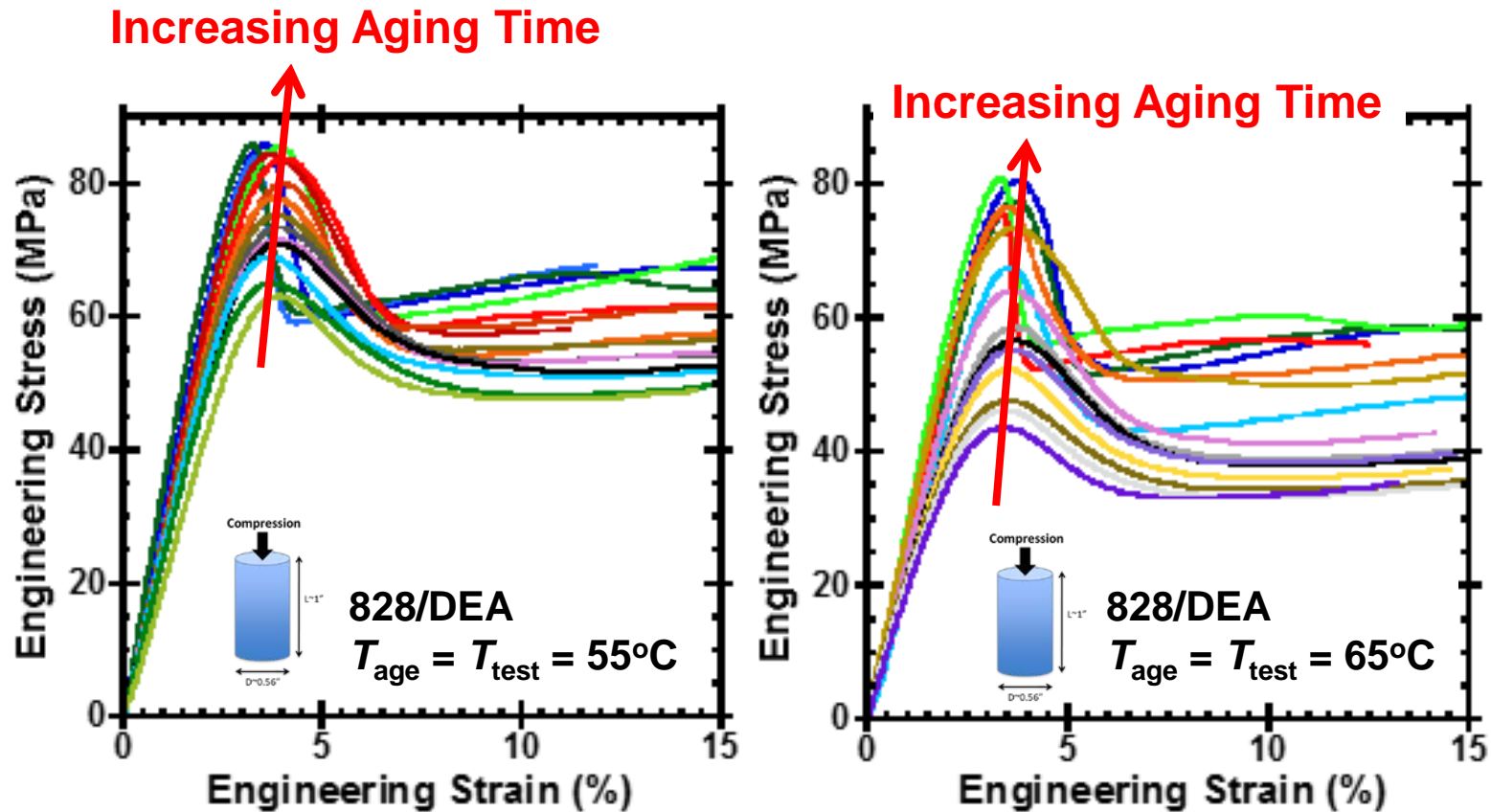
- The 50 nm instrument (length) resolution enables quantitative tracking of material length over time and provides the opportunity to resolve functionality [e.g., $l(t)$] that describes material behavior
- Minimizing potential for continued cure during “aging” by using “stoichiometric” epoxy thermosets (e.g., 828/T403) can have significant impact on material “shrinkage” magnitude

Mechanical

Anatomy of Compressive Stress-Strain Response of Glassy Polymers



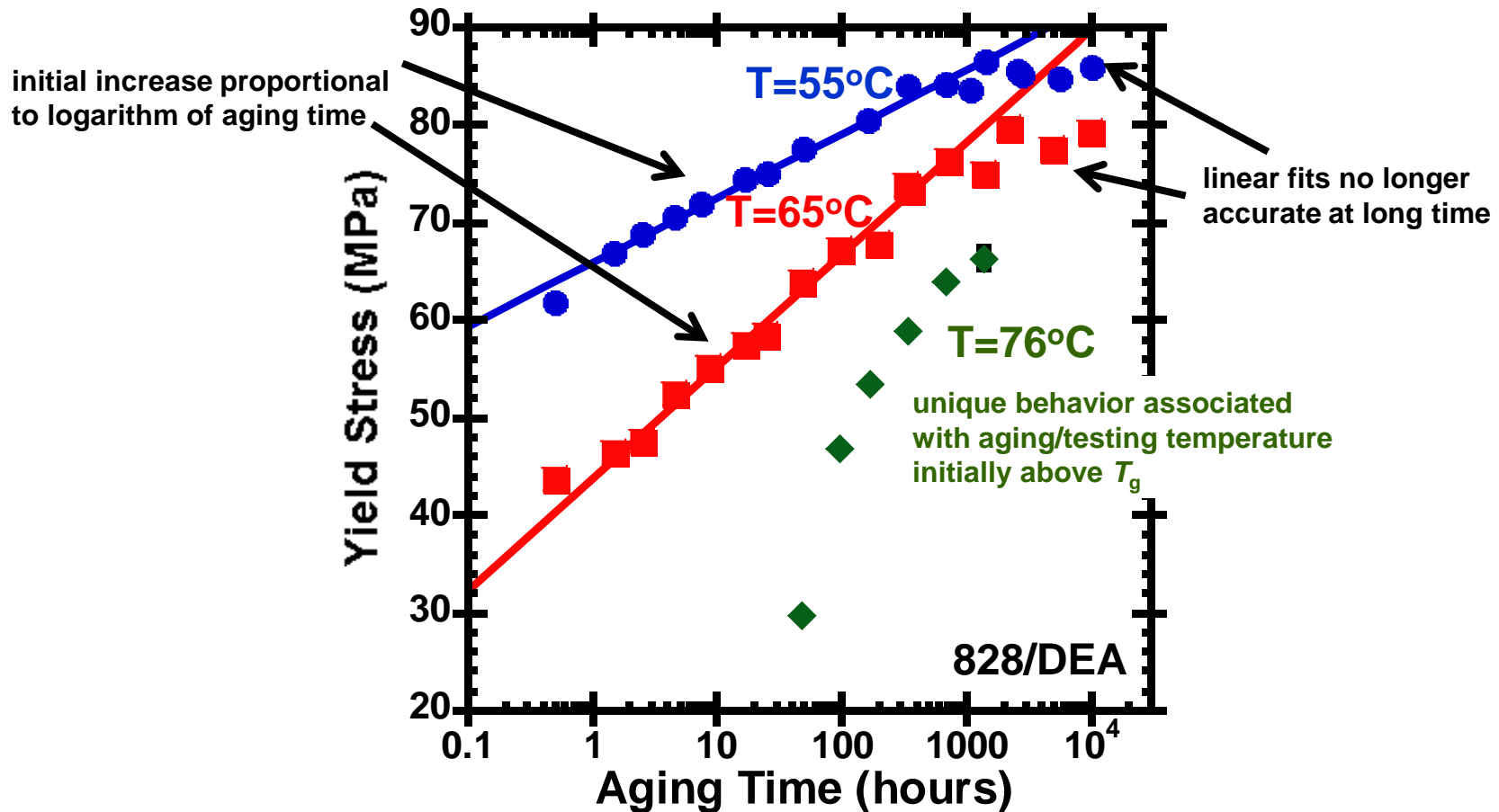
Changes in Compressive Stress-Strain Response Associated with Thermal Aging



4 Distinguishable Changes in Compressive Stress-Strain Response Include:

- Increase in “elastic” compressive modulus
- **Increase in “yield” stress**
- Narrowing of “yield” peak
- Increase in “flow” stress

Evolution of Yield Stress during Thermal Aging



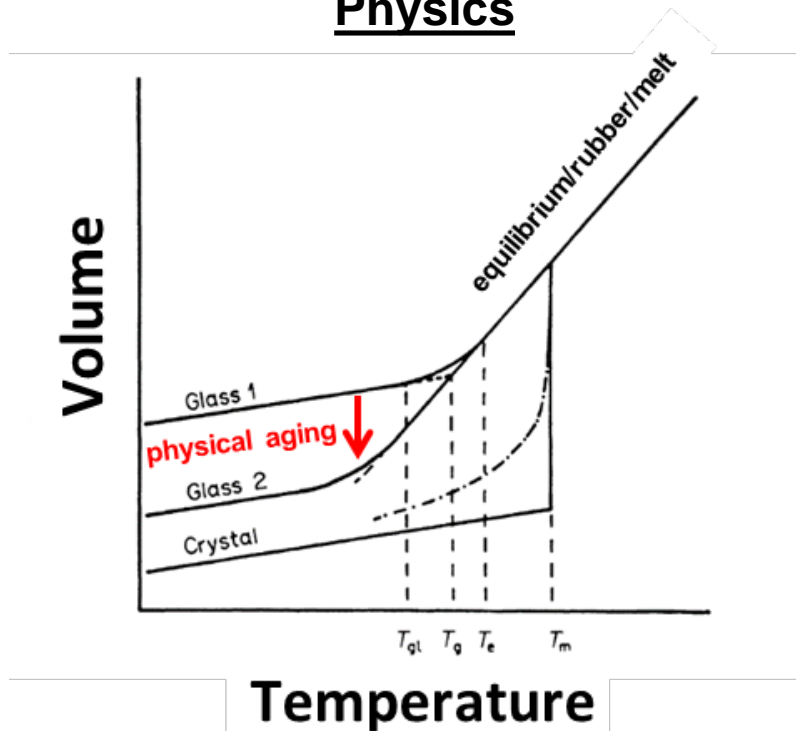
Focusing on $T = 55^{\circ}\text{C}$ and 65°C datasets for now:

- Changes in yield stress are substantial—as high as 82%
- The evolution of yield stress with time changes (or possibly stops) after ~ 30 days

What is the mechanism(s) driving this change?

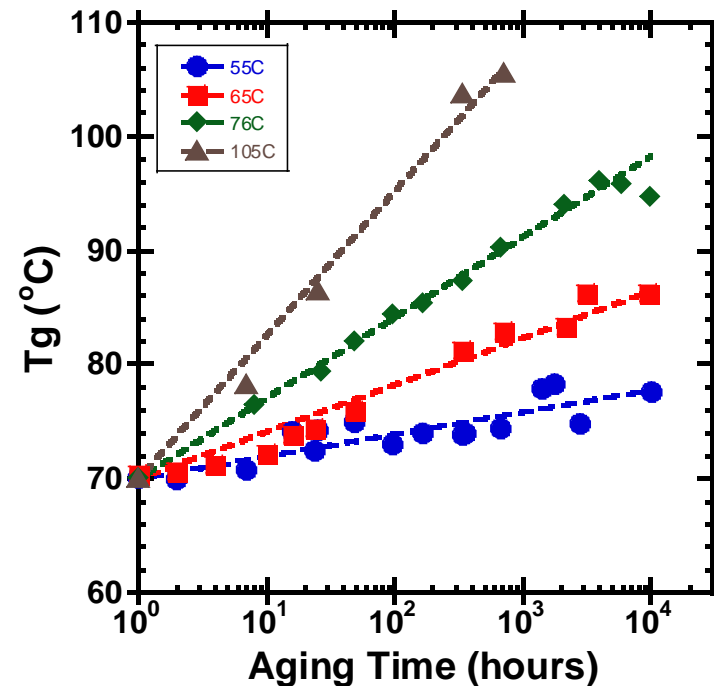
Mechanisms Driving Evolution of Yield Stress during Thermal Aging

Physics



Volume relaxation (densification) of the material slows molecular motions in the polymer chain and this contributes to an increase in the observed yield stress in the compressive stress-strain response

Chemistry

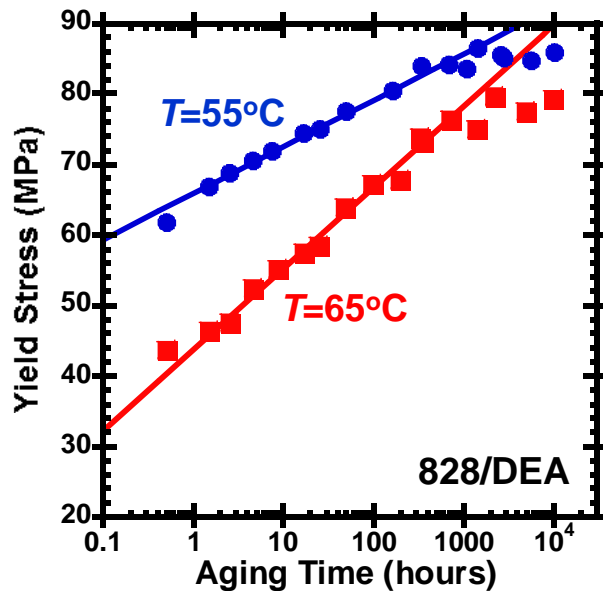


Continued chemical crosslinking increases the glass transition temperature of the material. This also slows molecular motions in the polymer chain (at a given temperature below T_g) and contributes to an increase in the observed yield stress in the compressive stress-strain response

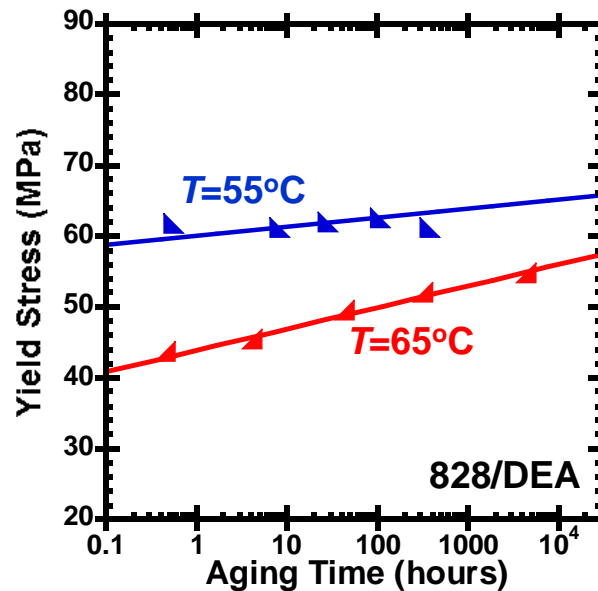
Can these contributions to the overall increase in yield stress be separated?

Chemical and Physical Contributions to the Evolution of Yield Stress during Thermal Aging

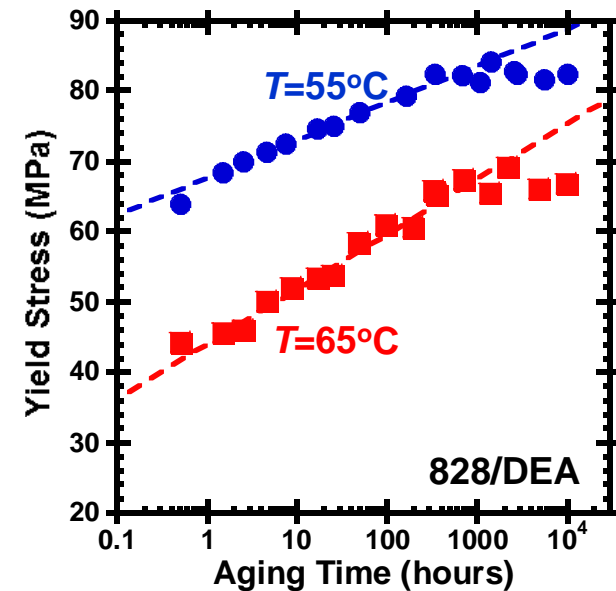
Chemical + Physical
(Measured)



Chemical Only
(Measured)

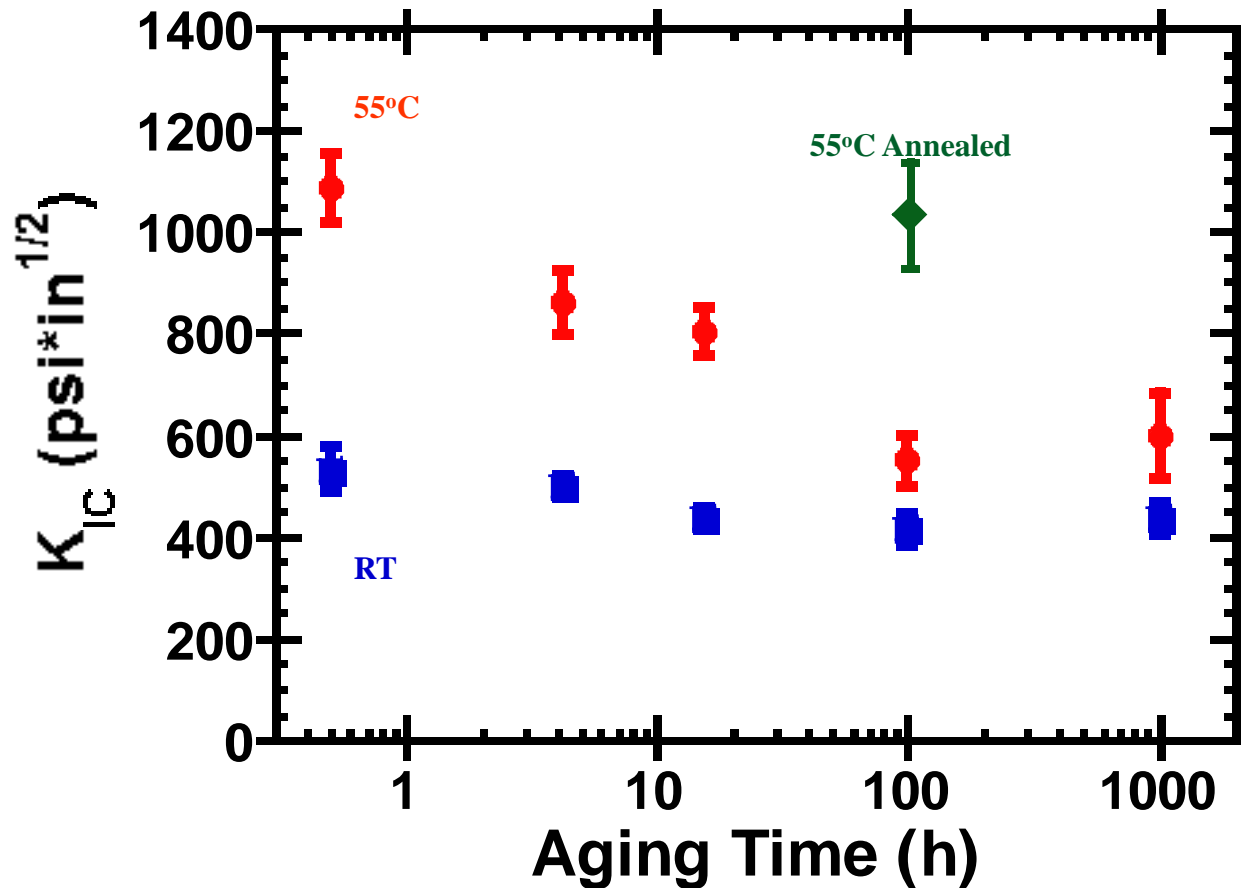


Physical Only
(Calculated)



By thermally annealing the samples above the glass transition temperature (after aging), the physical history of the sample is erased and the chemical-only contributions to the evolution of the yield stress are resolved. Physical-only contributions are calculated by subtracting the chemical-only contributions from the total change in yield stress.

Fracture Toughness Changes with Aging Too



Fracture Toughness Changes Occur Over the Same Timescale
and are Associated with Structural Relaxation

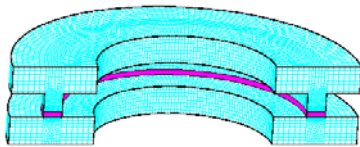
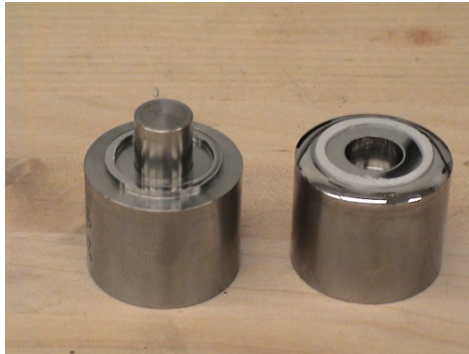
Summary

- Demonstrated ability to resolve in-situ material dimensional changes associated with isothermal aging under no mechanical load
- Illustrated differences in dimensional changes between materials associated with the specifics of a given material (e.g., remaining reaction potential that can occur under the aging conditions)
- Resolved substantial changes in the compressive yield stress (as high as 80%) of the 828/DEA material over relatively short times (~30 days) when aged and tested below, but near, the glass transition temperature (e.g., $T_g-10^{\circ}\text{C}$, $T_g-20^{\circ}\text{C}$)
- Resolved the apparent attainment of equilibrium, at which time there is no further change (associated with physics) in yield stress
- Discriminated between the chemical and physical contributions to the evolution of the yield stress during isothermal aging

Impact of Aging in Application- Relevant Geometries

Adhesion Failure Tests

Napkin Ring



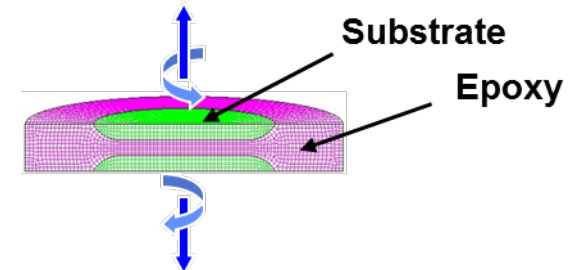
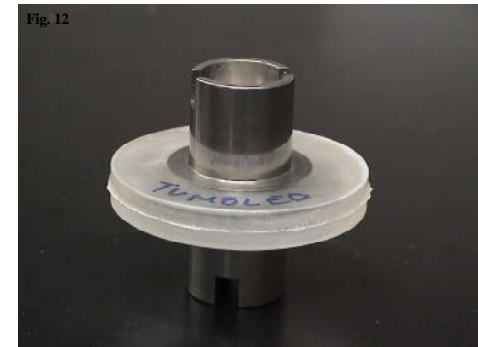
- Shear loading only (torsion)

test geometries
to measure
initiation of
adhesive failure

3-D Finite Element Models

- air interface is ill-defined
- induce initiation at an embedded surface

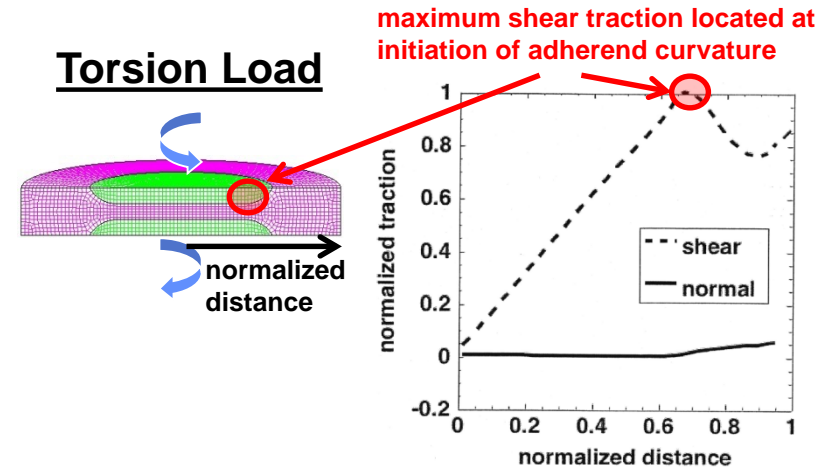
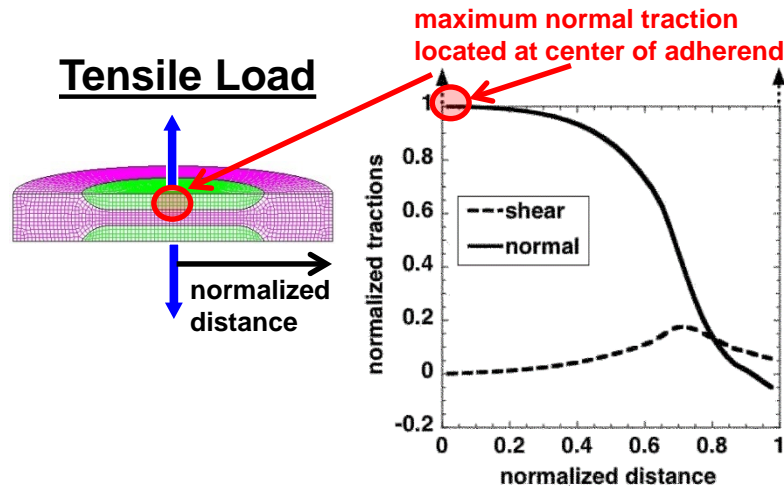
Saucer Design



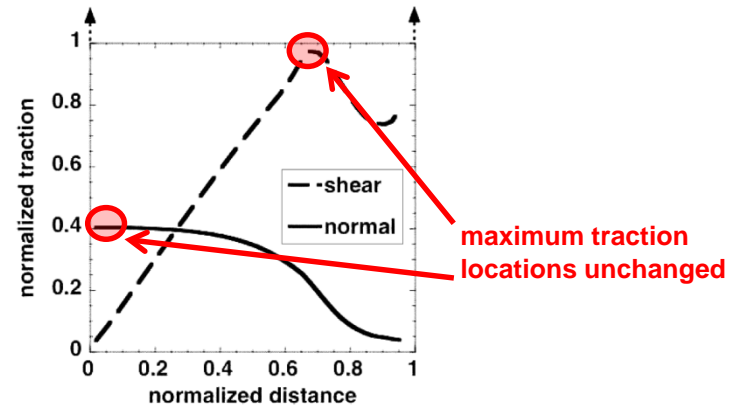
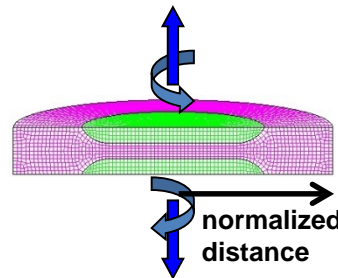
- Shear
- Tension/Compression
- Combined

Why “Saucer” Adhesion Test Geometry

1. Max stresses do not reside at an air interface (failure at “embedded interface”)



Combined Load (0.6% tensile strain + 1% shear strain)

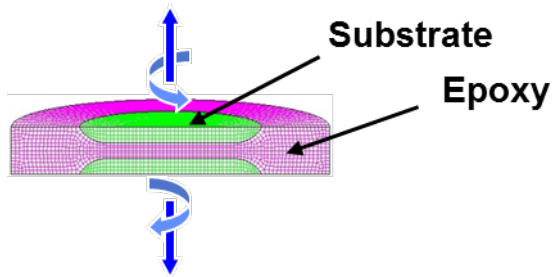


2. Max stresses are smooth functions, not “spiked”
3. Sample allows for mixed loading modes: tension, compression, shear, etc.

Aging Test

Saucer Test Geometry

Fig. 12



Initial focus on tensile loading only
(it may be the most sensitive to aging)

Aging Conditions

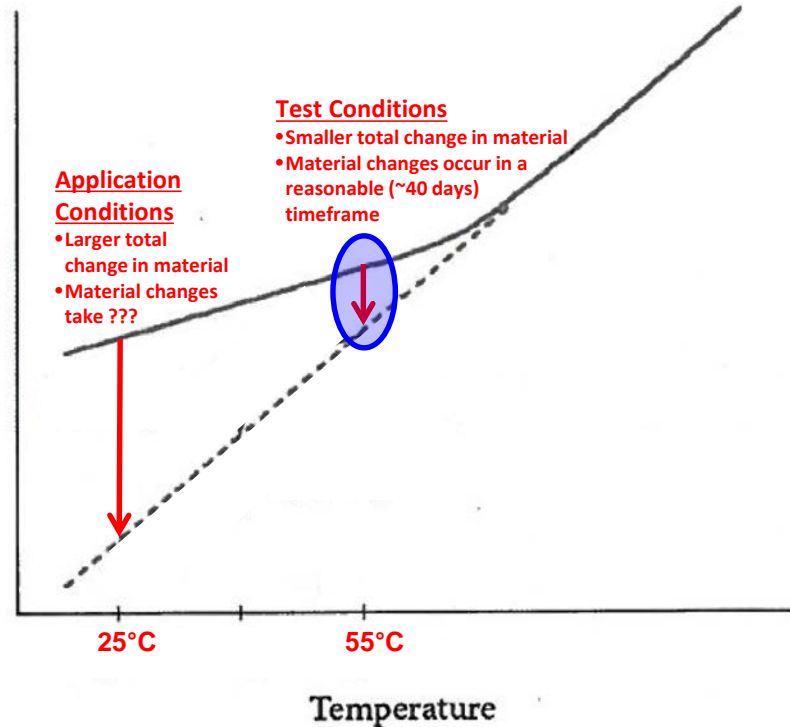
Volume
or
enthalpy

Application Conditions

- Larger total change in material
- Material changes take ???

Test Conditions

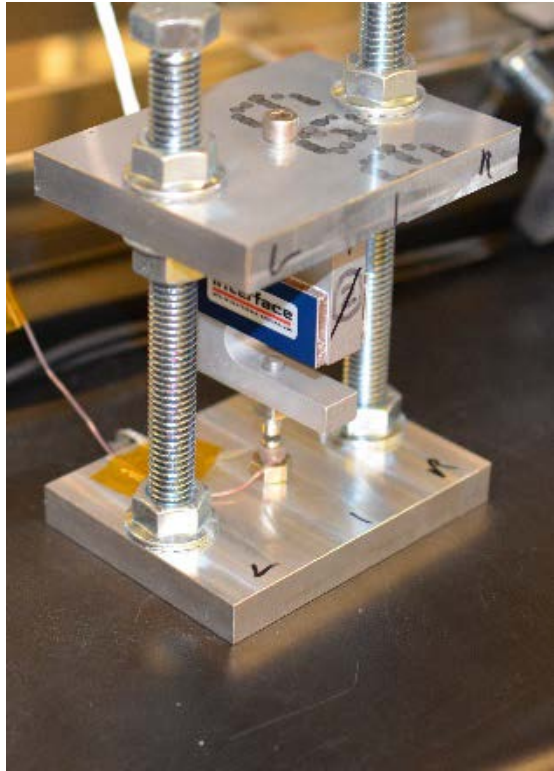
- Smaller total change in material
- Material changes occur in a reasonable (~40 days) timeframe



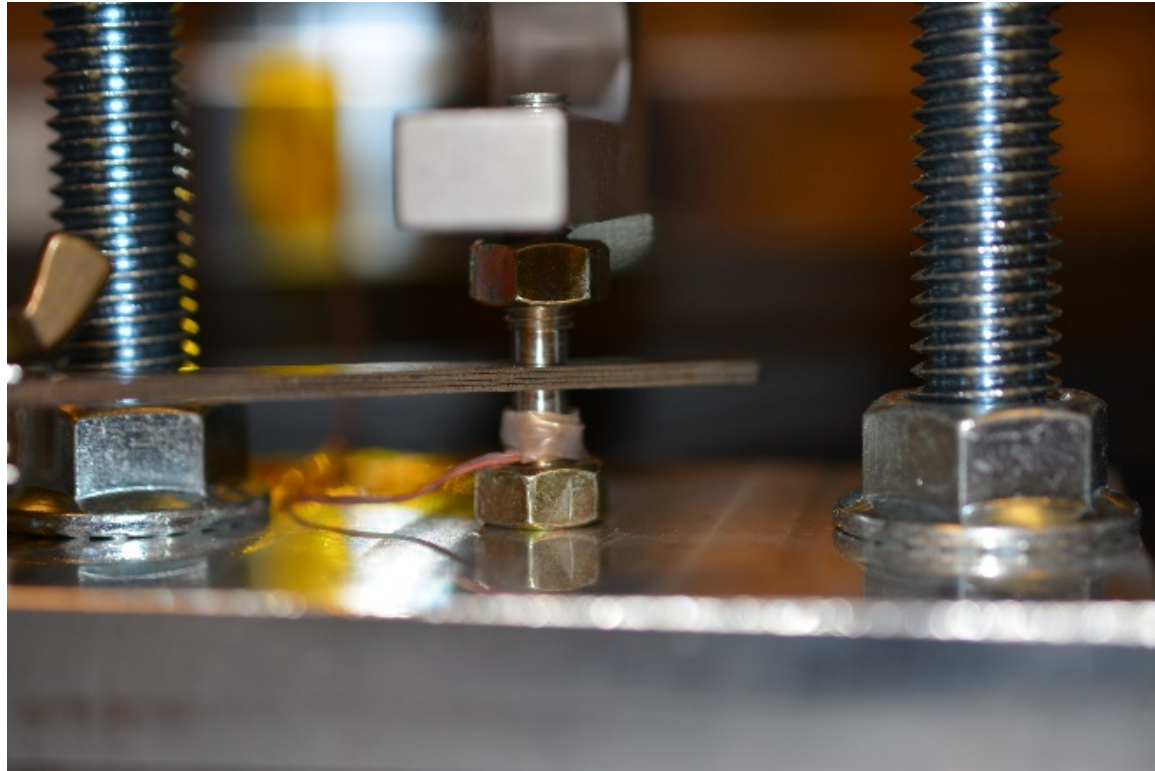
Results Coming Soon

Simple Structural Response Test for Validation

Confined Aging Experiment

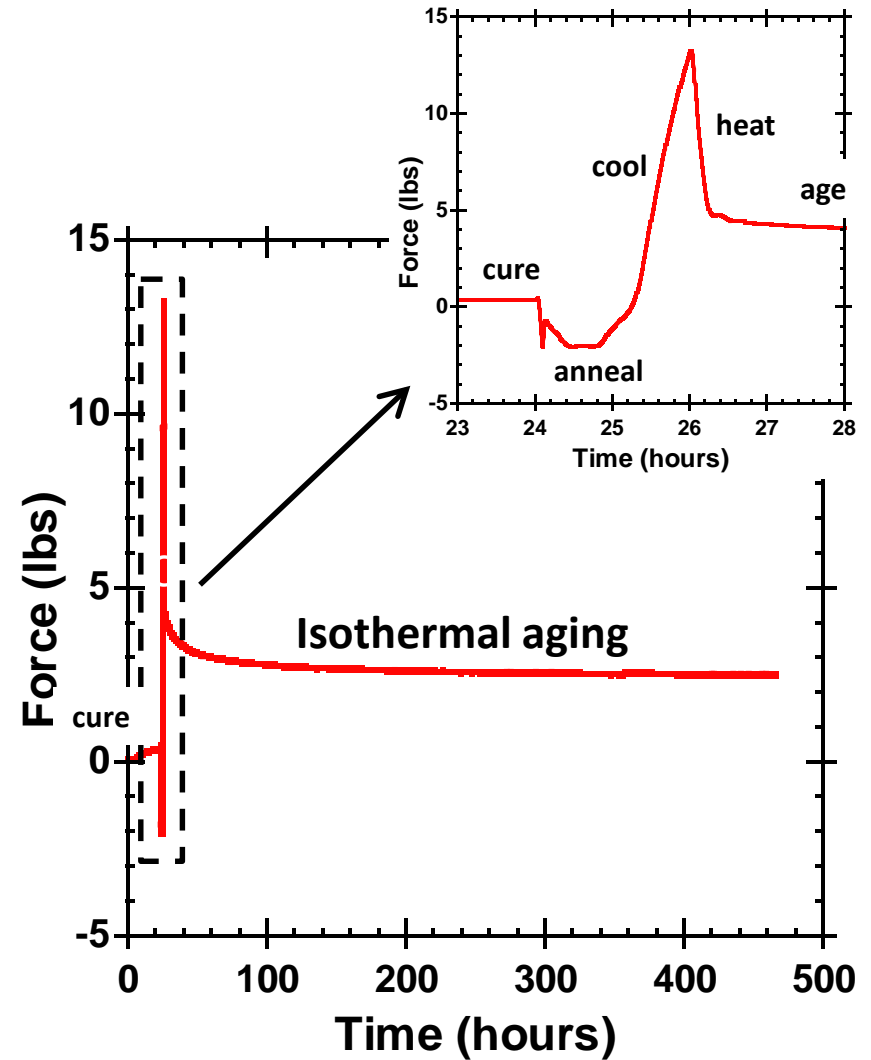
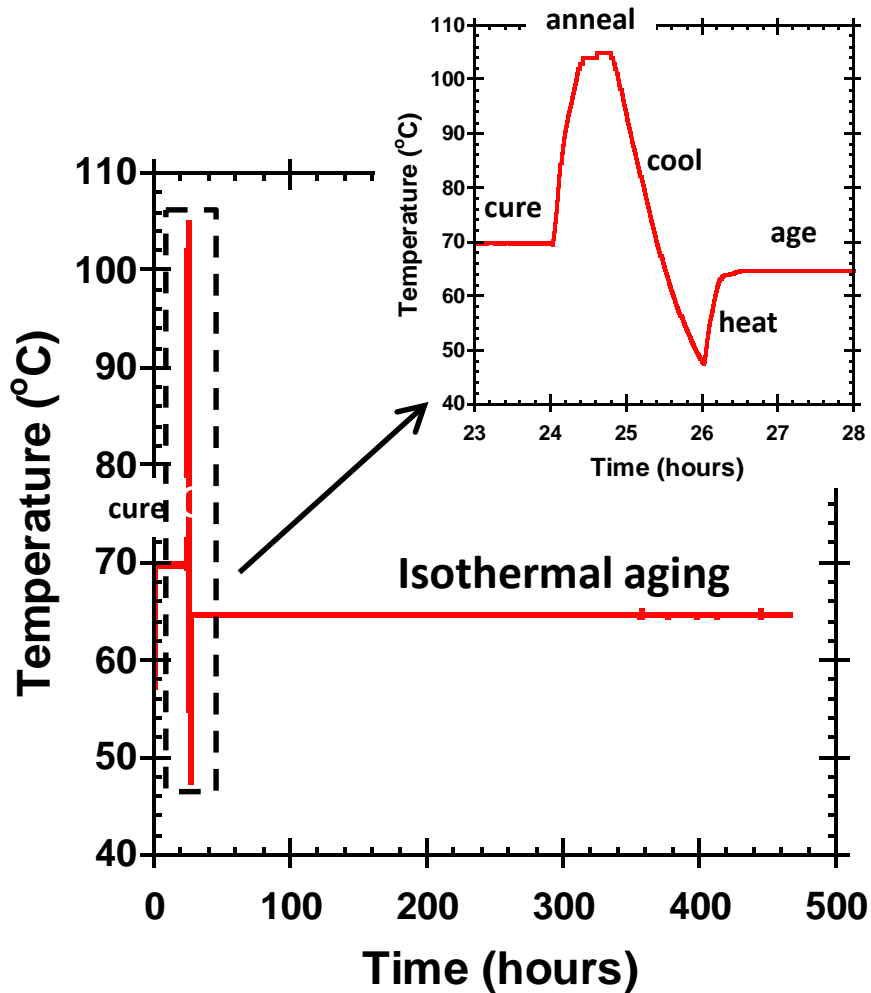


**Stiff Structure
With
Load Cell**



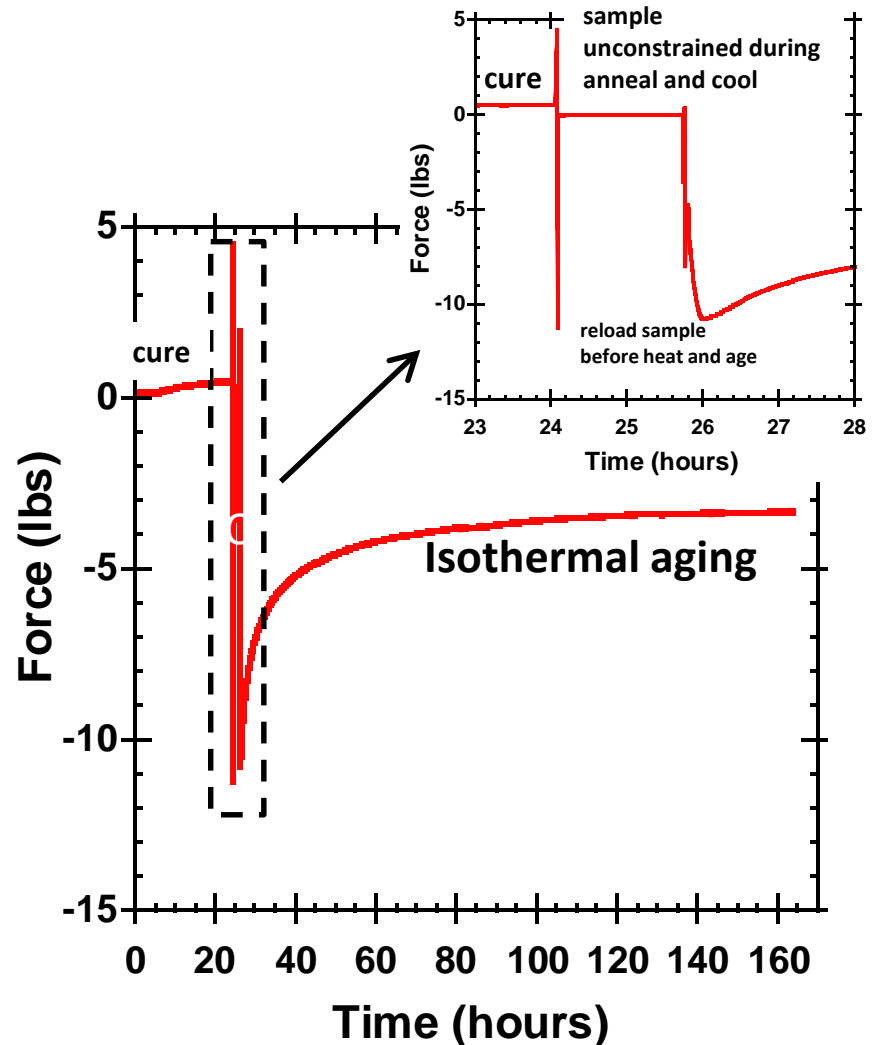
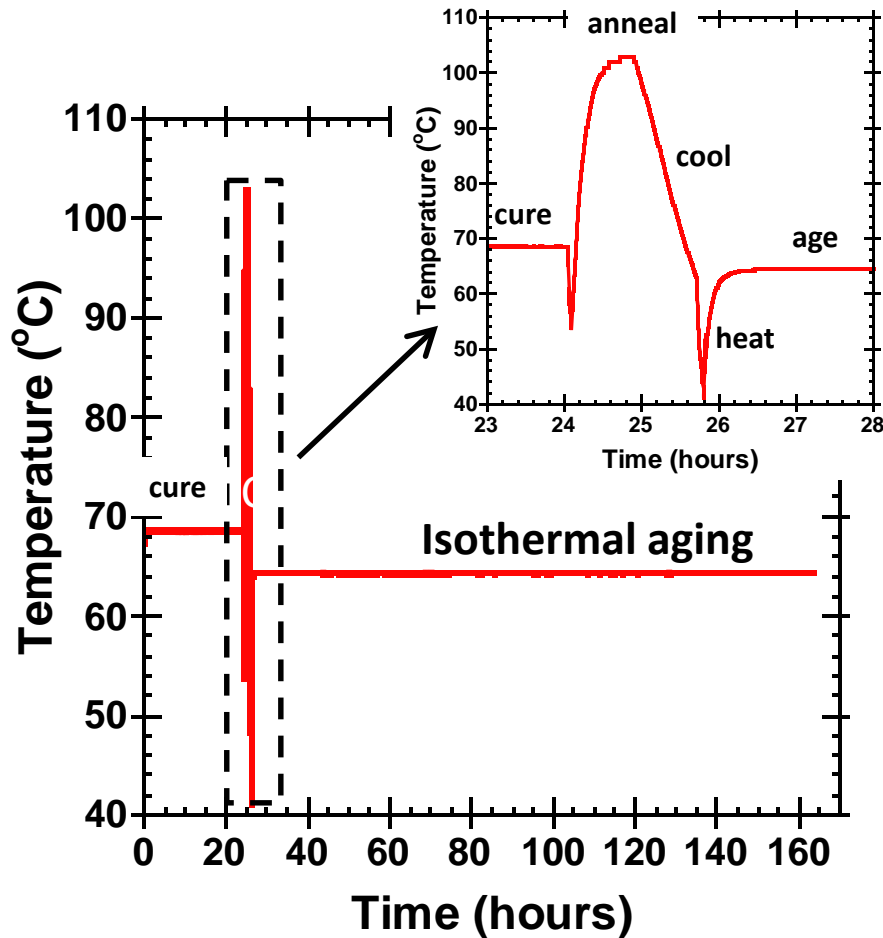
Defined Gap for Adhesive

Aging Under Tension



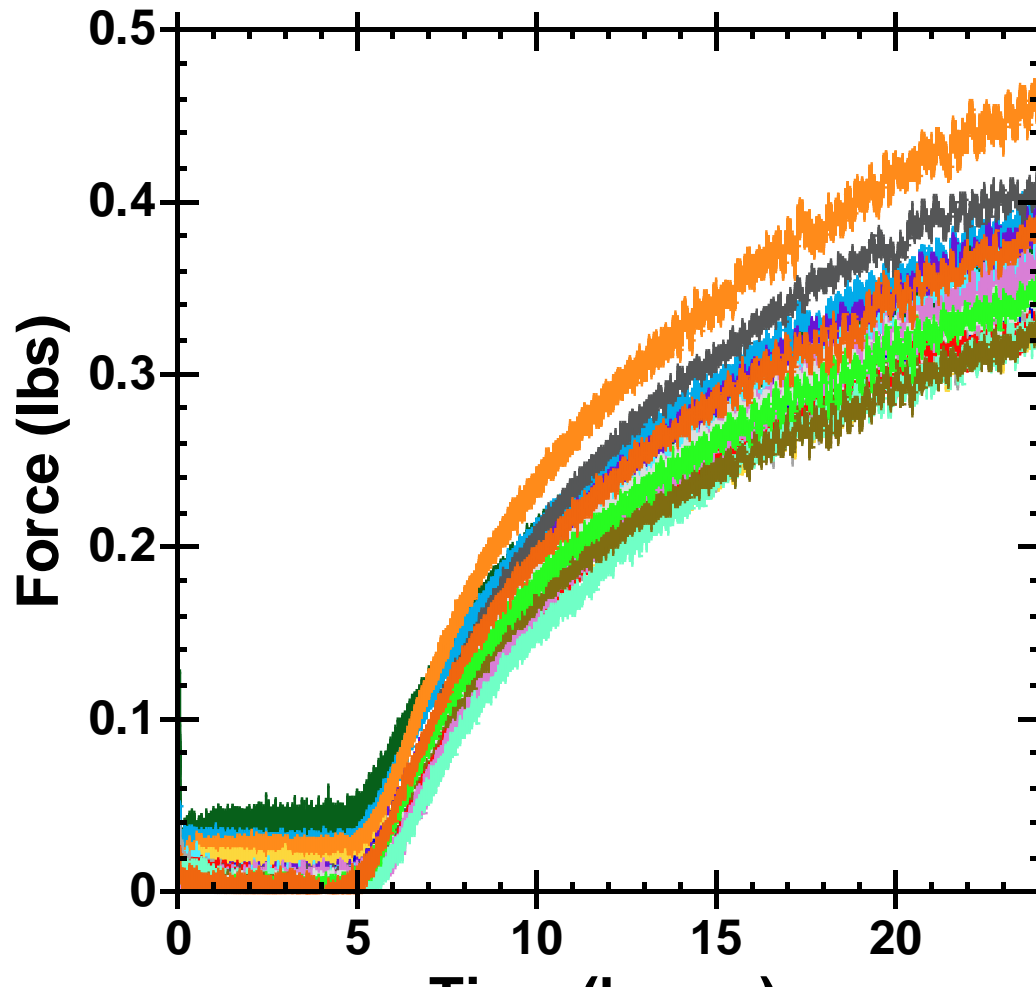
- Full thermal/force history captured from cure to aging
- Force decreases during isothermal aging, indicating stress relaxation dominates over physical aging under these test conditions

Aging Under Compression



- Cure, compressive loading during heating and aging history captured
- Magnitude of force decreases during isothermal aging. Both stress relaxation and physical aging tend to decrease the magnitude of force during isothermal aging under these conditions.

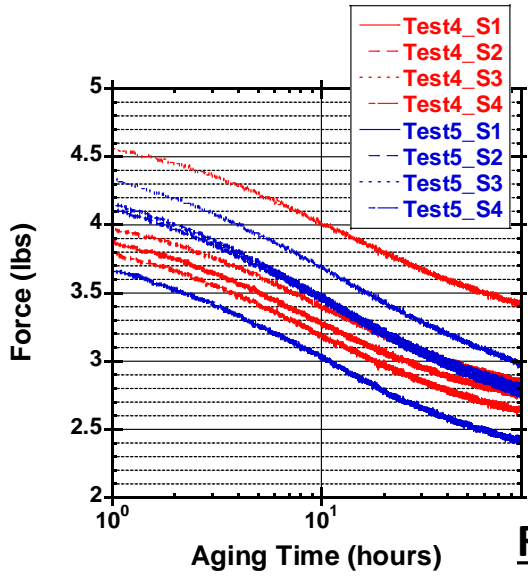
Reproducibility During Cure



- All tests give consistent measurement of the force developed during cure
- This provides another geometry (in addition to the Bimaterial Beam and the Thin-Disk-On-Cylinder) to assess stress associated with cure

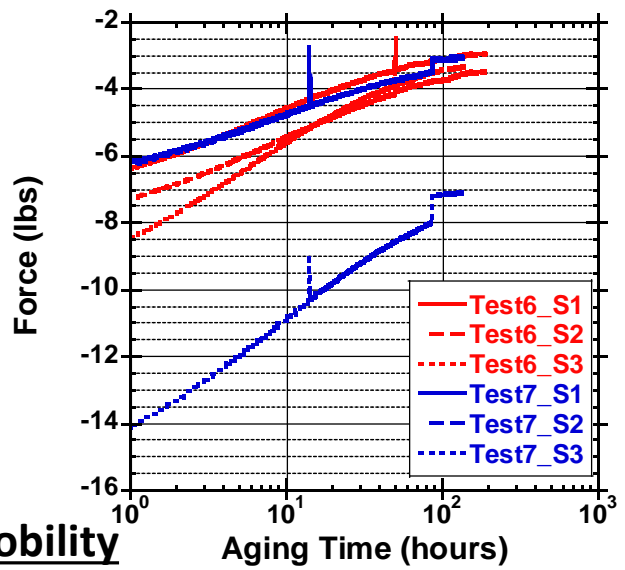
Aging Response

Under Tension

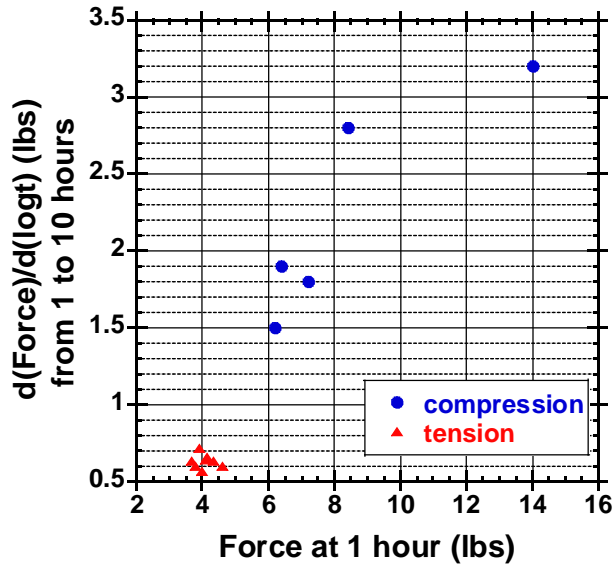


Change in force linear with log(time) for long periods

Under Compression



Resolution of Deformation Induced Mobility



Change in force faster under higher loads

Final Remarks

- We are actively examining structural recovery (volume, enthalpy) and physical aging (e.g., compressive stress-strain, fracture toughness) together in epoxy thermosets
 - Dimensional changes monitored at a high resolution
 - Significant changes in mechanical response (yield stress, fracture toughness) are observed to accompany structural relaxation
- Based on what is learned from materials testing, we are designing structural tests to examine the impact of materials aging on application designs
- More work is necessary to assess predictive capabilities of materials aging in order to build confidence in the tools to examine the impacts of application designs and environments